

(19)



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(11)

EP 0 872 888 A3

(12)

EUROPEAN PATENT APPLICATION

(88) Date of publication A3:
12.05.1999 Bulletin 1999/19

(51) Int. Cl.⁶: **H01L 23/60**, H01L 23/498,
H01L 23/66

(43) Date of publication A2:
21.10.1998 Bulletin 1998/43

(21) Application number: **97308907.1**

(22) Date of filing: **06.11.1997**

(84) Designated Contracting States:
**AT BE CH DE DK ES FI FR GB GR IE IT LI LU MC
NL PT SE**

Designated Extension States:
AL LT LV MK RO SI

(30) Priority: **16.04.1997 GB 9707679**

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(54) **Ball grid array module**

(57) A Plastic Ball Grid Array electronic package of the Cavity Down type for use in HF application. A Faraday Cage is realized to protect the active element from external HF wave interferences. The lateral sides of the Faraday Cage are constituted by a row of solder balls connected in a zig-zag way to plated through holes along the four edges of the substrate. The top side of the Cage is the metal stiffener of the Cavity Down package electrically connected to the through holes, while the bottom side is represented by the ground plane of the main board properly connected to the solder balls.

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EUROPEAN SEARCH REPORT

Application Number
EP 97 30 8907

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The present search report has been drawn up for all claims			
Place of search THE HAGUE		Date of completion of the search 18 March 1999	Examiner Prohaska, G
CATEGORY OF CITED DOCUMENTS X : particularly relevant if taken alone Y : particularly relevant if combined with another document of the same category A : technological background O : non-written disclosure P : intermediate document T : theory or principle underlying the invention E : earlier patent document, but published on, or after the filing date D : document cited in the application L : document cited for other reasons & : member of the same patent family, corresponding document			

**ANNEX TO THE EUROPEAN SEARCH REPORT
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